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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/643,461	08/18/2003	Qi Xiang	0180144	4140	
25700	7590 03/21/2005		EXAMINER		
	& FARJAMI LLP	NGUYEN, JOSEPH H			
26522 LA ALAMEDA AVENUE, SUITE 360 MISSION VIEJO, CA 92691			ART UNIT	PAPER NUMBER	
	<b></b> ,		2815		
			DATE MAILED: 03/21/2003	5	

Please find below and/or attached an Office communication concerning this application or proceeding.



## Advisory Action

Application No.	Applicant(s)	
10/643,461	XIANG ET AL.	
Examiner	Art Unit	
Joseph Nguyen	2815	

Potoro the Eiling of an Annual Priof								
Before the Filing of an Appeal Brief	Examiner	Art Unit						
	Joseph Nguyen	2815						
The MAILING DATE of this communication appe	ars on the cover sheet with the c	correspondence add	ress					
THE REPLY FILED <u>11 March 2005</u> FAILS TO PLACE THIS AF	PPLICATION IN CONDITION FOR	ALLOWANCE.						
The reply was filed after a final rejection, but prior to filing a Notice of Appeal. To avoid abandonment of this application, applicant must timely file one of the following replies: (1) an amendment, affidavit, or other evidence, which places the application in condition for allowance; (2) a Notice of Appeal (with appeal fee) in compliance with 37 CFR 41.31; or (3) a Request for Continued Examination (RCE) in compliance with 37 CFR 1.114. The reply must be filed within one of the following time periods:								
a) The period for reply expiresmonths from the mailing date of the final rejection.								
b) The period for reply expires on: (1) the mailing date of this Advisory Action, or (2) the date set forth in the final rejection, whichever is later. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of the final rejection.								
Examiner Note: If box 1 is checked, check either box (a) or (b). ONLY CHECK BOX (b) WHEN THE FIRST REPLY WAS FILED WITHIN TWO MONTHS OF THE FINAL REJECTION. See MPEP 706.07(f).								
Extensions of time may be obtained under 37 CFR 1.136(a). The date on been filed is the date for purposes of determining the period of extension a CFR 1.17(a) is calculated from: (1) the expiration date of the shortened stabove, if checked. Any reply received by the Office later than three month earned patent term adjustment. See 37 CFR 1.704(b).  NOTICE OF APPEAL	and the corresponding amount of the fee. atutory period for reply originally set in the	The appropriate extension final Office action; or (2)	on fee under 37 as set forth in (b)					
<ol> <li>The reply was filed after the date of filing a Notice of App</li> </ol>	eal, but prior to the date of filing ar	n appeal brief. The No	otice of Appeal					
was filed on A brief in compliance with 37 CFR 41.37 must be filed within two months of the date of filing the Notice of Appeal (37 CFR 41.37(a)), or any extension thereof (37 CFR 41.37(e)), to avoid dismissal of the appeal. Since a Notice of Appeal has been filed, any reply must be filed within the time period set forth in 37 CFR 41.37(a).  AMENDMENTS								
<ol> <li>The proposed amendment(s) filed after a final rejection,</li> </ol>	but prior to the date of filing a brie	f. will not be entered	because					
(a) ☐ They raise new issues that would require further co (b) ☐ They raise the issue of new matter (see NOTE belo (c) ☐ They are not deemed to place the application in be appeal; and/or	nsideration and/or search (see NO ow);	TE below);						
(d) They present additional claims without canceling a NOTE: (See 37 CFR 1.116 and 41.33(a)).		ejected claims.						
4. $\square$ The amendments are not in compliance with 37 CFR 1.1	121. See attached Notice of Non-C	ompliant Amendmen	t (PTOL-324).					
5. Applicant's reply has overcome the following rejection(s	•	er i er i e e e e						
<ol> <li>Newly proposed or amended claim(s) would be a the non-allowable claim(s).</li> </ol>	illowable if submitted in a separate	, timely filed amendn	nent canceling					
7. For purposes of appeal, the proposed amendment(s): a) how the new or amended claims would be rejected is pro The status of the claim(s) is (or will be) as follows: Claim(s) allowed:		vill be entered and an	explanation of					
Claim(s) objected to: Claim(s) rejected:								
Claim(s) rejected Claim(s) withdrawn from consideration:								
AFFIDAVIT OR OTHER EVIDENCE								
<ol> <li>The affidavit or other evidence filed after a final action, b because applicant failed to provide a showing of good ar and was not earlier presented. See 37 CFR 1.116(e).</li> </ol>	nd sufficient reasons why the affida	vit or other evidence	is necessary					
9. The affidavit or other evidence filed after the date of filing entered because the affidavit or other evidence failed to showing a good and sufficient reasons why it is necessary.  10. The affidavit or other evidence filed after the date of filing entered by the sufficient reasons why it is necessary.	overcome <u>all</u> rejections under appe ry and was not earlier presented. S	eal and/or appellant fa See 37 CFR 41.33(d)	ails to provide a (1).					
10. ☐ The affidavit or other evidence is entered. An explanation REQUEST FOR RECONSIDERATION/OTHER	on of the status of the claims after (	entry is below or atta	cnea.					
<ol> <li>The request for reconsideration has been considered by <u>See the next page.</u></li> </ol>	ut does NOT place the application i	in condition for allowa	ance because:					
12. Note the attached Information Disclosure Statement(s).  13. Other:	(PTO/SB/08 or PTO-1449) Paper	No(s)						
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Applicant argues that Kubo et al. fails to disclose "a first gate dielectric and a first gate electrode being selected such that a difference between the second coefficient of thermal expansion of the first gate electrode and the first coefficient of thermal expansion of the first gate dielectric causes an increase in carrier mobility in the FET". However, the coefficient of thermal expansion depends upon the material (see Exhibit A, Wolf et al). Since the first gate dielectric is made of silicon oxide and the first gate electrode made of polysilicon in Kubo et al., the second coefficient of thermal expansion of the first gate electrode is different from said first coefficient of thermal expansion of the first gate dielectric. Further, the phrase "causes an increase in carrier mobility in the FET" is merely functional language. The device of Kubo et al. would inherently cause an increase in carrier mobility due to the difference of coefficients of thermal expansion of polysilicon and silicon oxide. Lastly, the Wolf et al. reference is cited herein merely for providing a supporting evidence, not for being applied in the rejection. Therefore, the finality of the Office Action is proper

J.N.

ALLAN R. WILSON PRIMARY EXAMINER